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GHB-0603DU-CW2 1.6 x 0.8 mm White LED

1.SPECIFICATIONS

		(Ta=25°C)
Symbol	Absolute Maximum Rating	Unit
IF	20	mA
IFP	70	mA
VR	5	V
PD	80	mW
Topr	-20~+ 85	°C
Tstg	-30 ~ +100	°C
Tsld	Reflow Soldering : 260°C Hand Soldering : 350°C	for 10sec. for 3sec.
	Symbol IF IFP VR PD Topr Tstg Tstd	SymbolAbsolute Maximum RatingIF20IFP70VR5PD80Topr $-20 \sim + 85$ Tstg $-30 \sim +100$ TstdReflow Soldering : 260°CHand Soldering : 350°C

IFP Conditions : Pulse Width ≤ 10 msec. and Duty $\leq 1/10$

(2) Initial Electrical/Optical Characteristics

Item		Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage		VF	IF=10[mA]	-	3.6	4.0	V
Reverse Current		IR	VR=5[V]	-	-	50	μΑ
	Rank Q	Iv	IF=10[mA]	116	138	162	mcd
Luminous Intensity	Rank P	Iv	IF=10[mA]	81	98	116	mcd
	Rank O	Iv	IF=10[mA]	58	69	81	mcd

* Measurement Uncertainty of the Luminous Intensity : $\pm 10\%$

Color Ranks

	Rank a0						
x	0.280	0.264	0.283	0.296			
у	0.248	0.267	0.305	0.276			
		Rank b2					
х	0.296	0.287	0.330	0.330			
у	0.276	0.295	0.339	0.318			

	(IF=10mA,Ta=25°C)						
	Rank b1						
х	0.287	0.283	0.330	0.330			
у	0.295	0.305	0.360	0.339			
	Rank c0						
x	0.330	0.330	0.361	0.356			
у	0.318	0.360	0.385	0.351			

 \star Measurement Uncertainty of the Color Coordinates : $\pm\,0.01$

2.TYPICAL INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS Please refer to figure's page.

3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to figure's	page.		
Material as follows ;	Package	:	BT Resin
	Encapsulating Resin	:	Epoxy Resin (with Diffused + YAG Phosphor)
	Electrodes	:	Au Plating

(Ta=25°C)

 $(I_{\rm E}=10m \Lambda T_{\rm P}=2$

6.RELIABILITY (1) TEST ITEMS AND RESULTS

	Standard			Number of
Test Item	Test Method	Test Conditions	Note	Damaged
Resistance to	JEITA ED-4701	Tsld=260°C, 10sec.	2 times	0/50
Soldering Heat	300 301	(Pre treatment 30°C, 70%,168hrs.)		
(Reflow Soldering)				
Solderability	JEITA ED-4701	Tsld= $215 \pm 5^{\circ}$ C, 3sec.	1 time	0/50
(Reflow Soldering)	300 303	(Lead Solder)	over 95%	
Thermal Shock	JEITA ED-4701	0°C ~ 100°C	20 cycles	0/50
	300 307	15sec. 15sec.		
Temperature Cycle	JEITA ED-4701	$-30^{\circ}C \sim 25^{\circ}C \sim 100^{\circ}C \sim 25^{\circ}C$	100 cycles	0/50
	100 105	30min. 5min. 30min. 5min.		
Moisture Resistance Cyclic	JEITA ED-4701	25°C ~ 65°C ~ -10°C	10 cycles	0/50
	200 203	90%RH 24hrs./1cycle		
High Temperature Storage	JEITA ED-4701	Ta=100°C	1000 hrs.	0/50
	200 201		1. A.	2.6
Temperature Humidity	JEITA ED-4701	Ta=60°C, RH=90%	1000 hrs.	0/50
Storage	100 103			
Low Temperature Storage	JEITA ED-4701	Ta=-30°C	1000 hrs.	0/50
	200 202			
Steady State Operating Life		Ta=25°C, IF=20mA	500 hrs.	0/50
Steady State Operating Life		60°C, RH=90%, IF=10mA	500 hrs.	0/50
of High Humidity Heat			17.A	
Steady State Operating Life		Ta=-20°C, IF=10mA	1000 hrs.	0/50
of Low Temperature				
Vibration	JEITA ED-4701	100 ~ 2000 ~ 100Hz Sweep 4min.	48min.	0/50
	400 403	200m/s^2		
		3direction, 4cycles		
Substrate Bending	JEITA ED-4702	$3mm, 5 \pm 1$ sec.	1 time	0/50
Stick	JEITA ED-4702	$5N, 10 \pm 1 \text{ sec.}$	l time	0/50

(2) CRITERIA FOR JUDGING THE DAMAGE

			Criteria for Judgement		
Item	Symbol	Test Conditions	Min.	Max.	
Forward Voltage	VF	IF=10mA	-	U.S.L.*)× 1.1	
Reverse Current	Ir	Vr=5V	-	U.S.L.*)× 2.0	
Luminous Intensity	Iv	IF=10mA	L.S.L.**)× 0.5	-	

*) U.S.L.: Upper Standard Level *

**) L.S.L.: Lower Standard Level







7. CAUTIONS

White LEDs are devices which are materialized by combining Blue LEDs and special phosphors. Consequently, the color of White LEDs is changed a little by an operating current. Care should be taken after due consideration when using LEDs.

(1) Moisture Proof Package

- When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.
- The moisture proof package is made of an aluminum moisture proof bag with a zipper. A package of a moisture absorbent material (silica gel) is inserted into the moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

(2) Storage

- The LEDs should be kept at 30 degrees C or less and 90%RH or less. The LEDs should be used within a year. When storing LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.
- After opening the package, the LEDs should be kept at 30 degrees C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and reseal the moisture proof bag again.
- If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: more than 24 hours at $60 \pm 5^{\circ} C$

- Gilway LED electrode sections are comprised of a gold plate. The gold surface, may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the User use the LEDs as soon as possible.
- Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

(3) Heat Generation

- Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings in this specification.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4) Soldering Conditions

- The LEDs can be soldered in place using the reflow soldering method. Gilway cannot make a guarantee on the LEDs after they have been assembled using the dip soldering method.
- Recommended soldering conditions

Reflow Soldering			Hand Soldering			
Pre-heat Lead Solder 120 ~ 150°C		Lead-free Solder		Lead Solder	Lead-free Solder	
		180 ~ 200°C	Temperature	300°C Max.	350°C Max.	
Pre-heat time	Pre-heat time 120 sec. Max. 120 sec. Max.		Soldering time	3 sec. Max.	3 sec. Max.	
Peak 240°C Max. temperature	240°C Max.	260°C Max.		(one time only)	(one time only)	
Soldering time	oldering time 10 sec. Max. 10 sec. Max.			at the second of the		
Condition refer to refer to		refer to				
	Temperature	Temperature				
	- profile ①.	- profile @.				
		(N ₂ reflow is recommended.)				

<2 : Lead-free Solder>

* After reflow soldering rapid cooling should be avoided.

- [Temperature-profile (Surface of circuit board)]
 - Use the conditions shown to the under figure.

< 1: Lead Solder>





- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

(5) Cleaning

- It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

(6) Static Electricity

- Static electricity or surge voltage damages the LEDs. It is recommended that a wrist band or an antielectrostatic glove be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current. Criteria: (VF > 2.0V at IF=0.5mA)

(7) Others

- Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly at the LEDs with unaided eyes for more than a few seconds.
- The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Gilway's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Gilway. When defective LEDs are found, the User shall inform Gilway directly before disassembling or analysis.
- The formal specifications must be exchanged and signed by both parties before large volume purchas begins.
- The appearance and specifications of the product may be modified for improvement without notice.